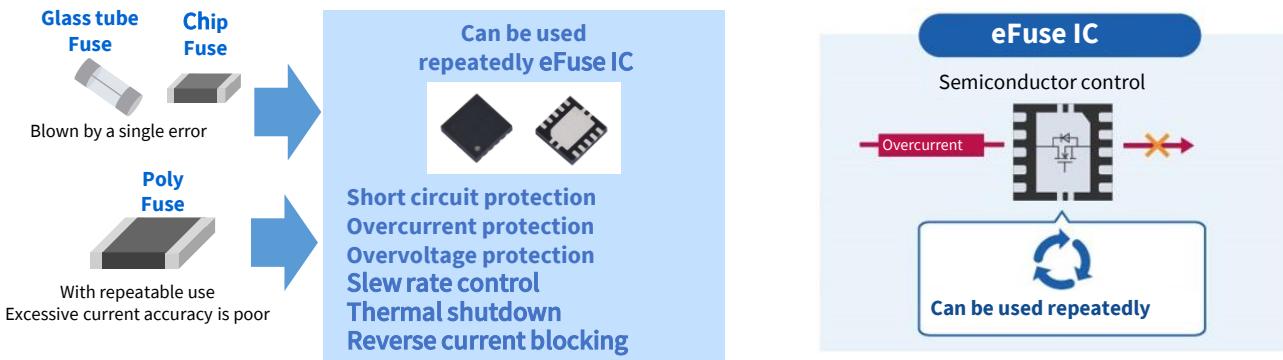


### eFuse IC for robust power supply protection

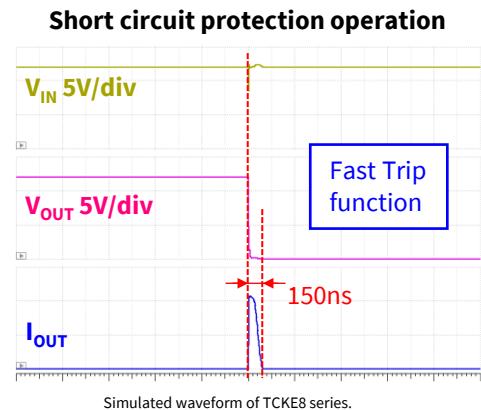
Toshiba eFuse IC incorporates high-performance, high-accuracy protective functions in a single package, which contributes to shorter designing times and robust protection of power supply lines.

#### Outline of TOSHIBA eFuse IC

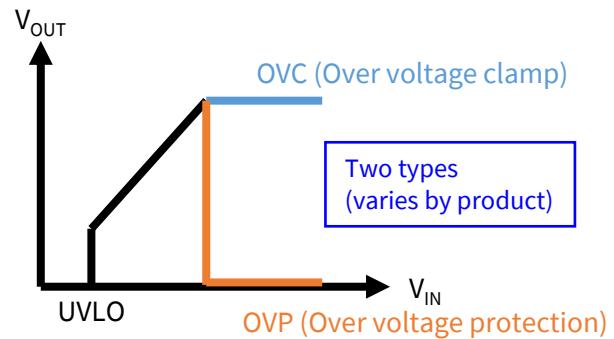
An eFuse IC is a semiconductor device with a fuse function designed to protect an electronic circuit from overcurrent conditions. The Toshiba eFuse IC has a lot of built-in protective functions and provide many advantages over physical fuses.



#### Main Protective Functions

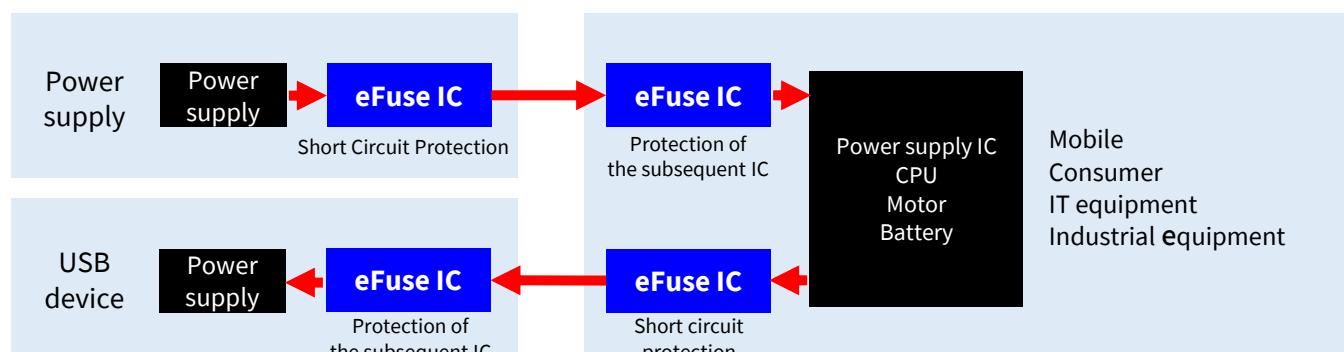


#### Overvoltage protection (OVC, OVP)



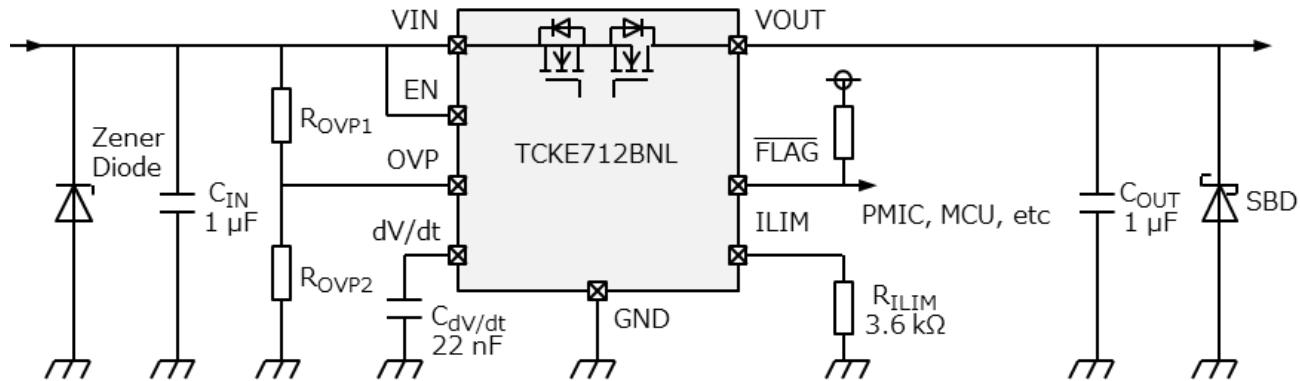
#### eFuse IC Applications diagram

It can be used for all applications requiring functions such as short circuit protection, overcurrent protection, overvoltage protection, slew rate control, reverse current blocking, and thermal shutdown.



## Example of power supply line combining eFuse IC with Zener diode and Schottky Barrier Diodes(SBD)

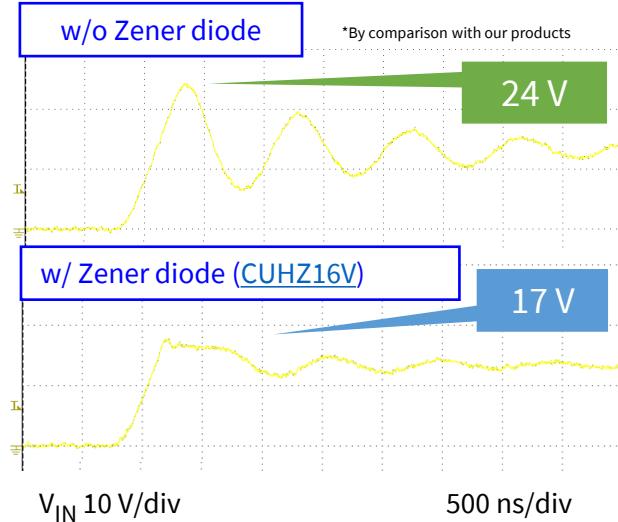
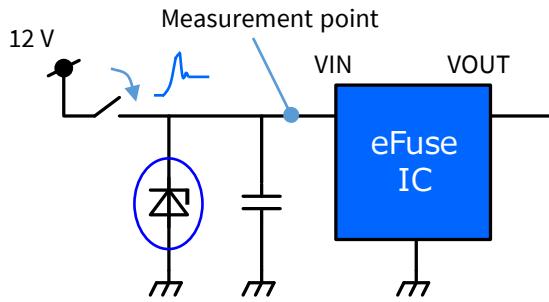
The eFuse IC has built-in overvoltage, overcurrent, and short circuit protection functions, but more robust power supply lines can be built by adding external components. If a Zener diode is connected between the input terminal and the GND terminal of eFuse IC, it provides a more robust protection against surges. In addition, the output may become a negative voltage due to the protective operation of eFuse IC, but the negative voltage can be reduced by connecting SBD.



NOTE :Select Zener diodes and SBDs considering the maximum rating of eFuse IC.

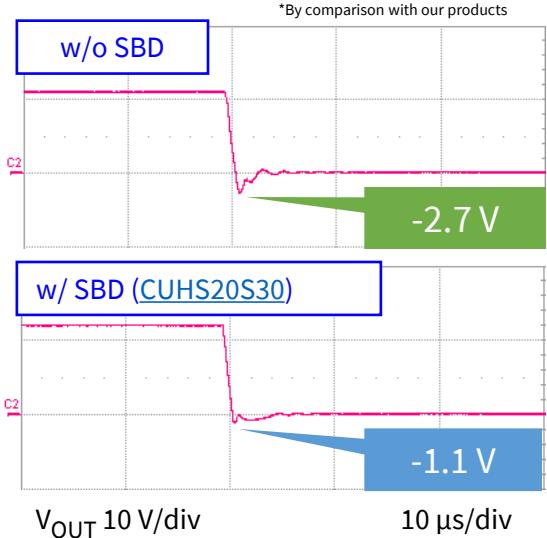
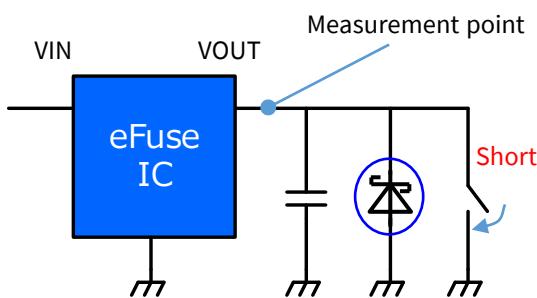
### Hot swap protection with Zener diode

Oversupply occurs when Hot swap. The Zener diodes can easily protect internal circuits.



### Negative voltage protection with SBD

A large negative voltage occurs the output side when the current path is cut off. The SBD can reduce negative voltage.



## •eFuse IC selection table

Product name	Package	Size (mm)	Electrical Characteristics /Switching Characteristics					Additional function								Certification		Purchase
			V <sub>IN</sub> /V (Min)	V <sub>IN</sub> /V (Max)	I <sub>out</sub> /A (DC)	R <sub>ON</sub> /mΩ (typ)	I <sub>Q</sub> /mA (typ)	Control Active	SRC	OAD	RCB	OVC/OVP	OCL	TSD	Recovery	Extra	IEC 62368-1 G9	
TCKE800NA	WSON10B	3x3	4.4	18	5	28	0.49	High	Adjustable	Y	Option (OFF)	N	0.5A to 5A Adjustable	Y	Auto-retry	-	Y	
TCKE805NA	WSON10B	3x3	4.4	18	5	28	0.46	High	Adjustable	Y	Option (OFF)	6.04V OVC	0.5A to 5A Adjustable	Y	Auto-retry	-	Y	
TCKE812NA	WSON10B	3x3	4.4	18	5	28	0.49	High	Adjustable	Y	Option (OFF)	15.1V OVC	0.5A to 5A Adjustable	Y	Auto-retry	-	Y	
TCKE800NL	WSON10B	3x3	4.4	18	5	28	0.49	High	Adjustable	Y	Option (OFF)	N	0.5A to 5A Adjustable	Y	Latched	-	Y	
TCKE805NL	WSON10B	3x3	4.4	18	5	28	0.46	High	Adjustable	Y	Option (OFF)	6.04V OVC	0.5A to 5A Adjustable	Y	Latched	-	Y	
TCKE812NL	WSON10B	3x3	4.4	18	5	28	0.49	High	Adjustable	Y	Option (OFF)	15.1V OVC	0.5A to 5A Adjustable	Y	Latched	-	Y	
TCKE712BNL	WSON10	3x3	4.4	13.2	3.65	53	0.69	High	Adjustable	N	Y (OFF)	Adjustable OVP	0.51A to 3.65A Adjustable	Y	Latched	FLAG	Y	
TCKE903NA	WSON8	2x2	2.7	23	4	34	0.18	High	Adjustable	Y	N	3.87V OVC	0.5A to 4A Adjustable	Y	Auto-retry	FLAG	Under planning	
TCKE903NL	WSON8	2x2	2.7	23	4	34	0.18	High	Adjustable	Y	N	3.87V OVC	0.5A to 4A Adjustable	Y	Latched	FLAG	Under planning	
TCKE905ANA	WSON8	2x2	2.7	23	4	34	0.18	High	Adjustable	Y	N	5.7V OVC	0.5A to 4A Adjustable	Y	Auto-retry	FLAG	Under planning	
TCKE905NL	WSON8	2x2	2.7	23	4	34	0.18	High	Adjustable	Y	N	5.7V OVC	0.5A to 4A Adjustable	Y	Latched	FLAG	Under planning	
TCKE912NA	WSON8	2x2	2.7	23	4	34	0.185	High	Adjustable	Y	N	13.7V OVC	0.5A to 4A Adjustable	Y	Auto-retry	FLAG	Under planning	
TCKE912NL	WSON8	2x2	2.7	23	4	34	0.185	High	Adjustable	Y	N	13.7V OVC	0.5A to 4A Adjustable	Y	Latched	FLAG	Under planning	
TCKE920NA	WSON8	2x2	2.7	23	4	34	0.19	High	Adjustable	Y	N	22.2V OVC	0.5A to 4A Adjustable	Y	Auto-retry	FLAG	Under planning	
TCKE920NL	WSON8	2x2	2.7	23	4	34	0.19	High	Adjustable	Y	N	22.2V OVC	0.5A to 4A Adjustable	Y	Latched	FLAG	Under planning	
TCKE903QNA	WSON8	2x2	3.0	23	4	34	0.18	High	Adjustable	Y	N	3.87V OVC	0.5A to 4A Adjustable	Y	Auto-retry	QOD	Under planning	
TCKE905QNA	WSON8	2x2	3.0	23	4	34	0.18	High	Adjustable	Y	N	5.7V OVC	0.5A to 4A Adjustable	Y	Auto-retry	QOD	Under planning	
TCKE601RA	TSOP6F	2.9x2.8	4.4	30	2.5	52	1	-	Fixed	Y	N	32V OVP	0.5A to 2.5A Adjustable	Y	Auto-retry	FLAG, Normally on	-	
TCKE601RL	TSOP6F	2.9x2.8	4.4	30	2.5	52	1	-	Fixed	Y	N	32V OVP	0.5A to 2.5A Adjustable	Y	Latched	FLAG, Normally on	-	
TCKE602RM	TSOP6F	2.9x2.8	4.4	30	2.5	52	1	-	Fixed	Y	N	32V OVP	0.5A to 2.5A Adjustable	Y	Selection type	MODE, Normally on	-	
TCKE603RA	TSOP6F	2.9x2.8	4.4	30	2.5	52	1	High	Fixed	Y	N	32V OVP	0.5A to 2.5A Adjustable	Y	Auto-retry	-	-	
TCKE603RL	TSOP6F	2.9x2.8	4.4	30	2.5	52	1	High	Fixed	Y	N	32V OVP	0.5A to 2.5A Adjustable	Y	Latched	-	-	

SRC: Slew rate control, OAD: Output auto-discharge, RCB: Reverse current blocking, OVC: Overvoltage clamp, OVP: Overvoltage protection (shutdown), OCL: Overcurrent limit, TSD: Thermal shutdown, QOD: Quick output discharge

WSON10B	WSON10	WSON8	TSOP6F
Bottom View  3.0 x 3.0	Bottom View  3.0 x 3.0	Bottom View  2.0 x 2.0	Bottom View  2.9 x 2.8

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